



I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date shown below.

Dated: August 19, 2002

Signature: [Signature]

(Marcus J. Millet)

Docket No.: TESSERA 3.0-299 10/16/2
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Damberg et al.

Application No.: 10/044,121

Group Art Unit: 281

Filed: January 11, 2002

Examiner: Not Yet Assigned

For: STACKED MICROELECTRONIC
ASSEMBLIES AND METHODS OF
MAKING SAME

Commissioner for Patents
Washington, DC 20231

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

It is respectfully requested that the references listed on the enclosed form be made of record and considered with respect to the above-referenced U.S. patent application. A copy of each reference is enclosed. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

In the event that any fee is due in connection with the present Information Disclosure Statement, the Commissioner is hereby authorized to charge the same to our Deposit Account No. 12-1095.

Dated: August 19, 2002

Respectfully submitted,

By [Signature]

Marcus J. Millet

Registration No.: 28,241

LERNER, DAVID, LITTENBERG,

KRUMHOLZ & MENTLIK, LLP

600 South Avenue West

Westfield, New Jersey 07090

(908) 654-5000

Attorneys for Applicant

384158_1.DOC

TECHNOLOGY CENTER 2800

SEP 11 2002

RECEIVED

RECEIVED

AUG 23 2002